

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re U.S. Patent Application of** )  
 )  
**YAMAMOTO et al.** )  
 )  
**Application Number: To be Assigned** )  
 )  
**Filed: Concurrently Herewith** )  
 )  
**For: SEMICONDUCTOR INTEGRATED CIRCUIT DEVICE** )  
**AND MANUFACTURING METHOD THEREOF** )  
 )  
**ATTORNEY DOCKET NO. HITA.0536** )

**Honorable Assistant Commissioner  
for Patents  
Washington, D.C. 20231**

**INFORMATION DISCLOSURE STATEMENT**

Sir:

Pursuant to 37 C.F.R. §§ 1.56 and 1.97, this Information Disclosure Statement is submitted in the above-identified patent application. A listing of documents to be published on the face of any patent granted from this application is submitted herewith on Form PTO-1449. Any other documents or information submitted for consideration by the Examiner are listed in this paper. A copy of each U.S. and foreign patent, or each publication or portion thereof listed or herein identified, is submitted herewith.

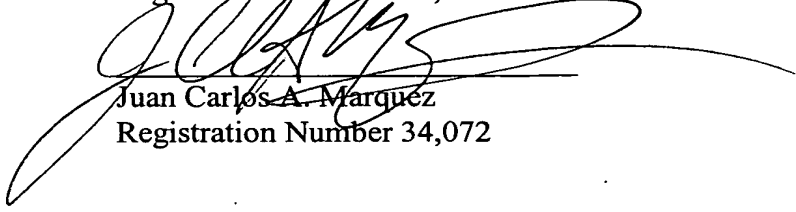
This Information Disclosure Statement is submitted with the initial filing of the application. Accordingly, no fee is due or payable at this time.

The Examiner is requested to acknowledge consideration of the information provided in this paper in accordance with prescribed procedures.

Please charge any additional fees or credit any overpayments in connection with this paper to Deposit Account No. 08-1480.

Respectfully submitted,

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